

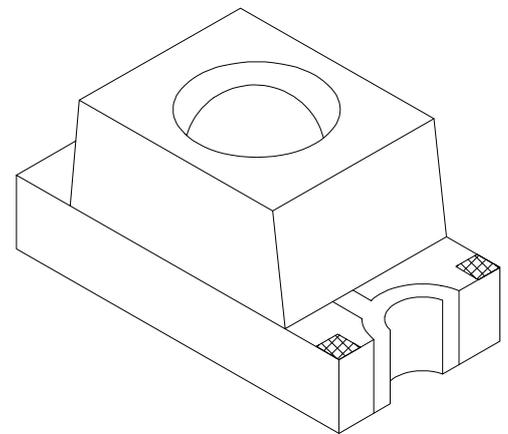
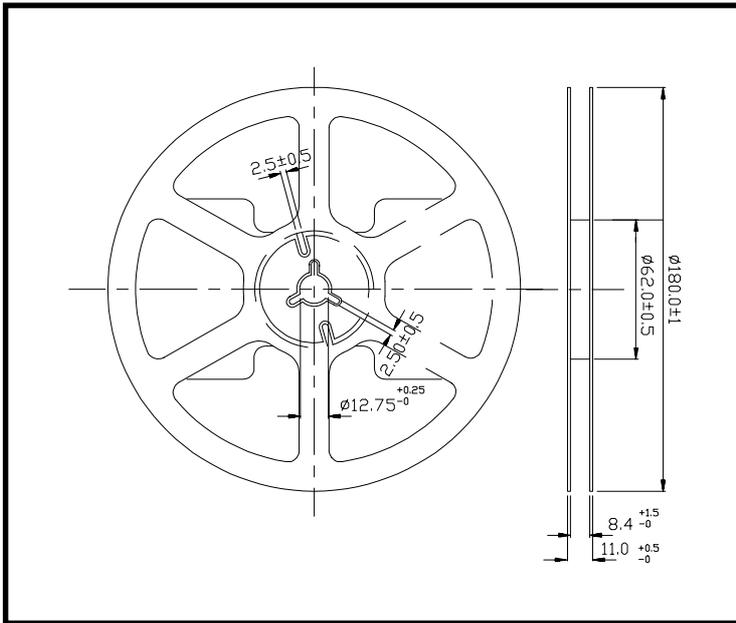


MODEL NO: 11-21 SRC/TR8
1206 Package Chip LEDs with Inner Lens

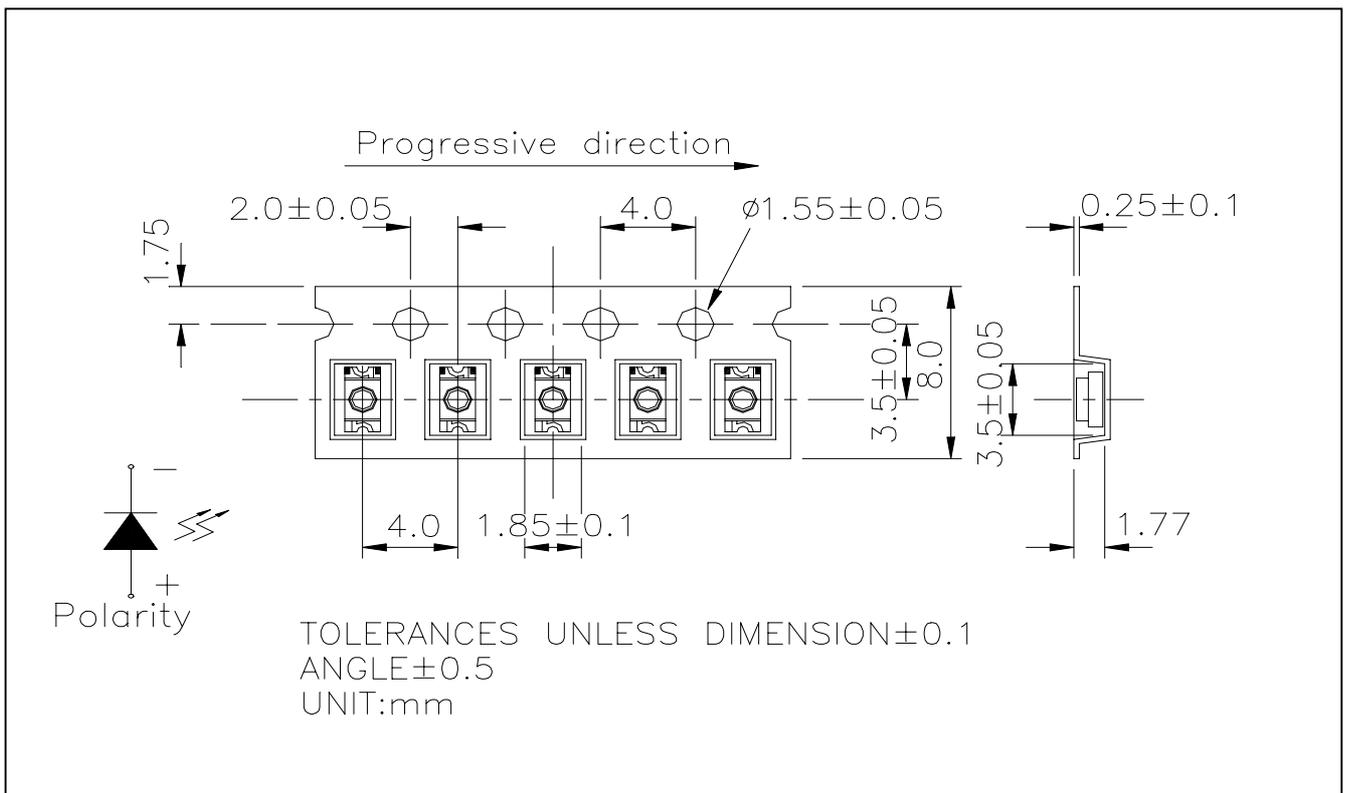
Device Number : DSE-111-019 REV. 1.1

ECN : _____ Page: 2/8

Package Dimensions :



Loaded quantity per reel 2000 PCS/reel :





MODEL NO: 11-21 SRC/TR8
1206 Package Chip LEDs with Inner Lens

Device Number : DSE-111-019 REV. 1.1

ECN : Page: 3/8

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	40	mA
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +90	°C
Soldering Temperature	T _{sol}	260 (for 5 second)	°C
Power Dissipation	P _d	110	mW
Peak Forward Current(Duty 1/10 @ 1KHZ)	I _{FPeak}	180	mA

Electronic Optical Characteristics :

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous intensity	I _v	30	51	-----	mcd	I _F =20mA
Viewing Angle	2θ 1/2	-----	20	-----	deg	I _F =20mA
Peak Wavelength	λ _p	-----	660	-----	nm	I _F =20mA
Dominant Wavelength	λ _d	-----	643	-----	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ	-----	20	-----	nm	I _F =20mA
Forward Voltage	V _F	1.5	1.7	2.4	V	I _F =20mA
Reverse Current	I _R	-----	-----	10	μA	V _R =5V



MODEL NO: 11-21 SRC/TR8
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Device Number : DSE-111-019 REV. 1.1

ECN : _____ Page: 4/8

■ Reliability Test Item And Condition

NO	Item	Test Conditions	Test Hours/Cycle	Sample Size	Ac/Re
1	Solder Heat	TEMP : 260°C ± 5 °C	5 SEC	76 PCS	0/1
2	Temperature Cycle	H : +85°C 30min § 5 min L : -55°C 30min	50 CYCLE	76 PCS	0/1
3	Thermal Shock	H : +100°C 5min § 10 sec L : -10°C 5min	50 CYCLE	76 PCS	0/1
4	High Temperature Storage	TEMP : 100°C	1000 HRS	76 PCS	0/1
5	Low Temperature Storage	TEMP : -55°C	1000 HRS	76 PCS	0/1
6	DC Operating Life	I _F = 20 mA	1000 HRS	76 PCS	0/1
7	High Temperature / High Humidity	85°C /85% RH	1000 HRS	76 PCS	0/1

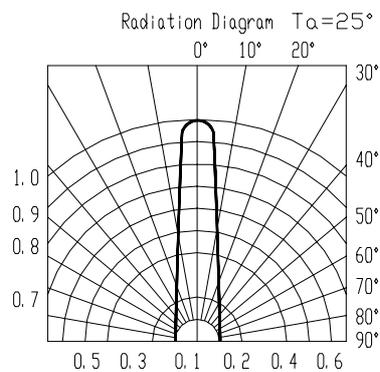
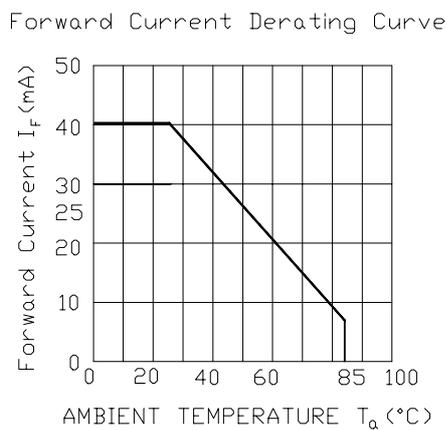
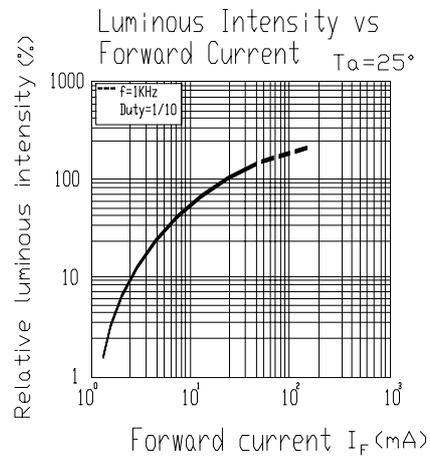
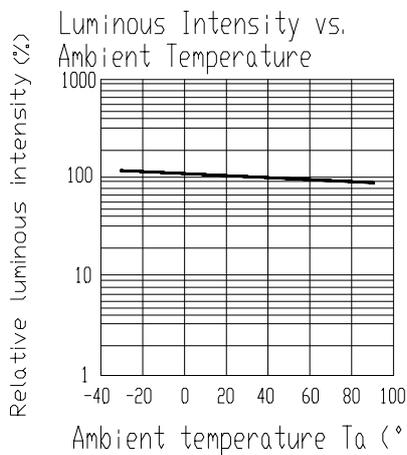
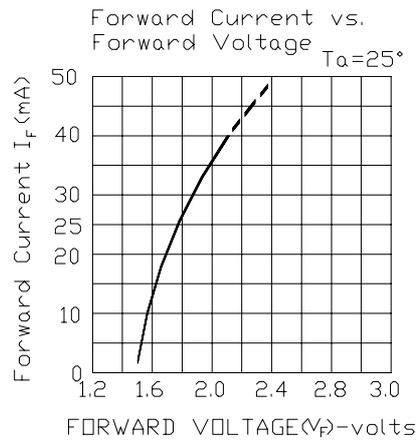
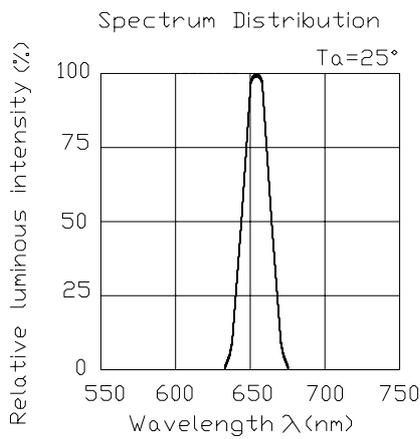


MODEL NO: 11-21 SRC/TR8
1206 Package Chip LEDs with Inner Lens

Device Number : DSE-111-019 REV. 1.1

ECN : _____ Page: 5/8

Typical Electro-Optical Characteristic Curves



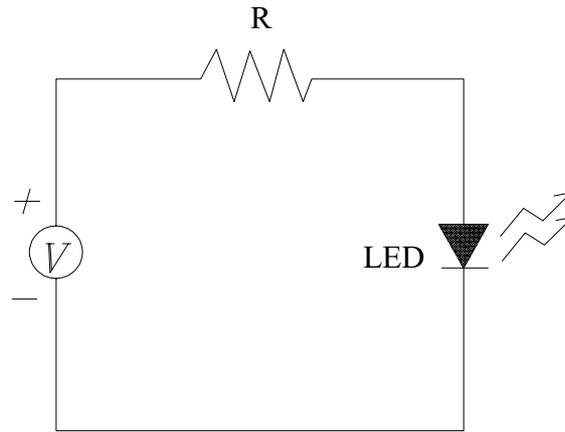


MODEL NO: 11-21 SRC/TR8
1206 Package Chip LEDs with Inner Lens

Device Number : DSE-111-019 REV. 1.1

ECN : _____ Page: 6/8

■ Test Circuit



■ Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage time

2.1 The operation of temperature and R.H. are : $5^{\circ}\text{C}\sim 35^{\circ}\text{C}$, R.H.60%.

2.2 Once the package is opened, the products should be used within a week. Otherwise, they should be keeping in a dampproof box with desiccants. Considering the tape life , we suggest our customers to use our products within a year(from production date).

2.3 If opened more than one week in an atmosphere $5^{\circ}\text{C}\sim 35^{\circ}\text{C}$, R.H.60%, they should be treated at $60^{\circ}\text{C}\pm 5^{\circ}\text{C}$ for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color (normal = blue) , you should treat them in the same conditions as 2.3.



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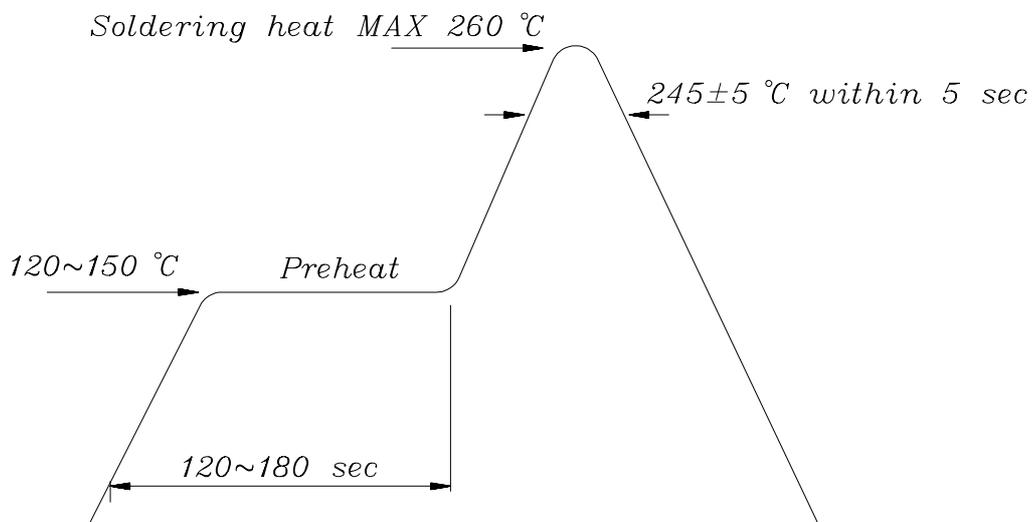
Device Number : DSE-111-019 REV. 1.1

1206 Package Chip LEDs with Inner Lens

ECN : _____ Page: 7/8

■ **Soldering heat reliability (DIP)**

Please refer to the following figure :

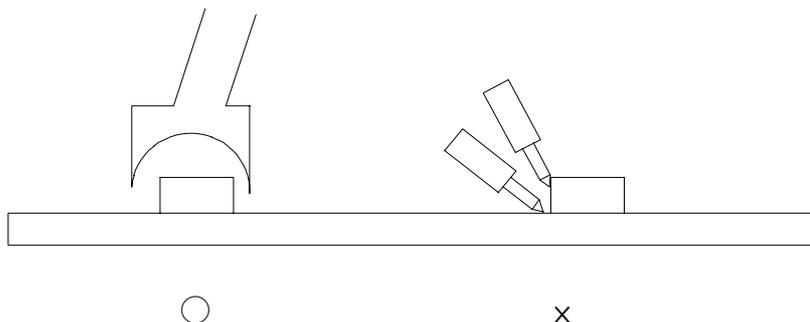


■ **Soldering Iron**

Basic spec is ≤ 5 sec when 260°C. If temperature is higher, time should be shorter (+10°C → -1sec). Power dissipation of iron should be smaller than 15 W , and temperature should be controllable. Surface temperature of the device should be under 230 °C .

■ **Rework**

1. Customer must finish rework within 5 sec under 260°C .
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.





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Device Number : DSE-111-019 REV. 1.1

ECN : Page: 8/8

■ Reflow Temp / Time :

